

**Triacs**

**BT136X series**

**GENERAL DESCRIPTION**

Passivated triacs in a full pack plastic envelope, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

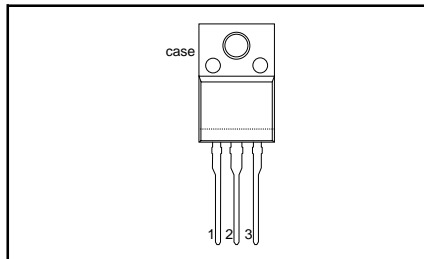
**QUICK REFERENCE DATA**

| SYMBOL       | PARAMETER                            | MAX.        | MAX.       | UNIT |
|--------------|--------------------------------------|-------------|------------|------|
|              |                                      | <b>600</b>  | <b>800</b> |      |
|              |                                      | <b>600F</b> |            |      |
| $V_{DRM}$    | Repetitive peak off-state voltages   | 600         | 800        | V    |
| $I_{T(RMS)}$ | RMS on-state current                 | 4           | 4          | A    |
| $I_{TSM}$    | Non-repetitive peak on-state current | 25          | 25         | A    |

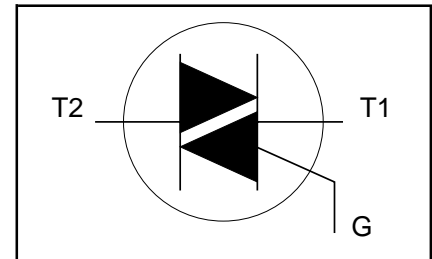
**PINNING - SOT186A**

| PIN  | DESCRIPTION     |
|------|-----------------|
| 1    | main terminal 1 |
| 2    | main terminal 2 |
| 3    | gate            |
| case | isolated        |

**PIN CONFIGURATION**



**SYMBOL**



**LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL       | PARAMETER                                                    | CONDITIONS                                                                    | MIN. | MAX.                     |             | UNIT             |
|--------------|--------------------------------------------------------------|-------------------------------------------------------------------------------|------|--------------------------|-------------|------------------|
|              |                                                              |                                                                               |      | -600<br>600 <sup>1</sup> | -800<br>800 |                  |
| $V_{DRM}$    | Repetitive peak off-state voltages                           |                                                                               | -    |                          |             | V                |
| $I_{T(RMS)}$ | RMS on-state current                                         | full sine wave; $T_{hs} \leq 92^\circ\text{C}$                                | -    | 4                        |             | A                |
| $I_{TSM}$    | Non-repetitive peak on-state current                         | full sine wave; $T_j = 25^\circ\text{C}$ prior to surge                       | -    | 25                       |             | A                |
|              |                                                              | $t = 20\text{ ms}$                                                            | -    | 27                       |             | A                |
|              |                                                              | $t = 16.7\text{ ms}$                                                          | -    | 3.1                      |             | A <sup>2</sup> s |
|              |                                                              | $t = 10\text{ ms}$                                                            | -    |                          |             |                  |
| $I^2t$       | $I^2t$ for fusing                                            |                                                                               | -    | 50                       |             | A/μs             |
| $di_T/dt$    | Repetitive rate of rise of on-state current after triggering | $I_{TM} = 6\text{ A}; I_G = 0.2\text{ A}; di_G/dt = 0.2\text{ A}/\mu\text{s}$ | -    | 50                       |             | A/μs             |
|              |                                                              | T2+ G+                                                                        | -    | 50                       |             | A/μs             |
|              |                                                              | T2+ G-                                                                        | -    | 50                       |             | A/μs             |
|              |                                                              | T2- G-                                                                        | -    | 10                       |             | A/μs             |
|              |                                                              | T2- G+                                                                        | -    | 2                        |             | A                |
| $I_{GM}$     | Peak gate current                                            |                                                                               | -    | 5                        |             | V                |
| $V_{GM}$     | Peak gate voltage                                            |                                                                               | -    | 5                        |             | W                |
| $P_{GM}$     | Peak gate power                                              |                                                                               | -    | 0.5                      |             | W                |
| $P_{G(AV)}$  | Average gate power                                           | over any 20 ms period                                                         | -    | 150                      |             | °C               |
| $T_{stg}$    | Storage temperature                                          |                                                                               | -40  | 125                      |             | °C               |
| $T_j$        | Operating junction temperature                               |                                                                               | -    |                          |             |                  |

<sup>1</sup> Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 3 A/μs.

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**ISOLATION LIMITING VALUE & CHARACTERISTIC** $T_{hs} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified

| SYMBOL     | PARAMETER                                                              | CONDITIONS                                                                                   | MIN. | TYP. | MAX. | UNIT |
|------------|------------------------------------------------------------------------|----------------------------------------------------------------------------------------------|------|------|------|------|
| $V_{isol}$ | R.M.S. isolation voltage from all three terminals to external heatsink | $f = 50\text{-}60\text{ Hz}$ ; sinusoidal waveform;<br>$R.H. \leq 65\%$ ; clean and dustfree | -    | -    | 2500 | V    |
| $C_{isol}$ | Capacitance from T2 to external heatsink                               | $f = 1\text{ MHz}$                                                                           | -    | 10   | -    | pF   |

**THERMAL RESISTANCES**

| SYMBOL                | PARAMETER                               | CONDITIONS                                   | MIN. | TYP. | MAX. | UNIT |
|-----------------------|-----------------------------------------|----------------------------------------------|------|------|------|------|
| $R_{th\ j\text{-}hs}$ | Thermal resistance junction to heatsink | full or half cycle<br>with heatsink compound | -    | -    | 5.5  | K/W  |
| $R_{th\ j\text{-}a}$  | Thermal resistance junction to ambient  | without heatsink compound<br>in free air     | -    | 55   | 7.2  | K/W  |

**STATIC CHARACTERISTICS** $T_j = 25\text{ }^{\circ}\text{C}$  unless otherwise stated

| SYMBOL   | PARAMETER                 | CONDITIONS                                                                           | MIN. | TYP. | MAX. |      | UNIT |
|----------|---------------------------|--------------------------------------------------------------------------------------|------|------|------|------|------|
| $I_{GT}$ | Gate trigger current      | <b>BT136X-</b><br>$V_D = 12\text{ V}$ ; $I_T = 0.1\text{ A}$                         | -    | -    | ...  | ...F |      |
|          |                           | T2+ G+                                                                               | -    | 5    | 35   | 25   | mA   |
|          |                           | T2+ G-                                                                               | -    | 8    | 35   | 25   | mA   |
|          |                           | T2- G-                                                                               | -    | 11   | 35   | 25   | mA   |
|          |                           | T2- G+                                                                               | -    | 30   | 70   | 70   | mA   |
| $I_L$    | Latching current          | $V_D = 12\text{ V}$ ; $I_{GT} = 0.1\text{ A}$                                        | -    | -    | -    | -    |      |
|          |                           | T2+ G+                                                                               | -    | 7    | 20   | 20   | mA   |
|          |                           | T2+ G-                                                                               | -    | 16   | 30   | 30   | mA   |
|          |                           | T2- G-                                                                               | -    | 5    | 20   | 20   | mA   |
|          |                           | T2- G+                                                                               | -    | 7    | 30   | 30   | mA   |
| $I_H$    | Holding current           | $V_D = 12\text{ V}$ ; $I_{GT} = 0.1\text{ A}$                                        | -    | 5    | 15   | 15   | mA   |
| $V_T$    | On-state voltage          | $I_T = 5\text{ A}$                                                                   | -    | 1.4  | 1.70 |      | V    |
| $V_{GT}$ | Gate trigger voltage      | $V_D = 12\text{ V}$ ; $I_T = 0.1\text{ A}$                                           | -    | 0.7  | 1.5  |      | V    |
|          |                           | $V_D = 400\text{ V}$ ; $I_T = 0.1\text{ A}$ ;<br>$T_j = 125\text{ }^{\circ}\text{C}$ | 0.25 | 0.4  | -    |      | V    |
| $I_D$    | Off-state leakage current | $V_D = V_{DRM(max)}$ ;<br>$T_j = 125\text{ }^{\circ}\text{C}$                        | -    | 0.1  | 0.5  |      | mA   |

## Triacs

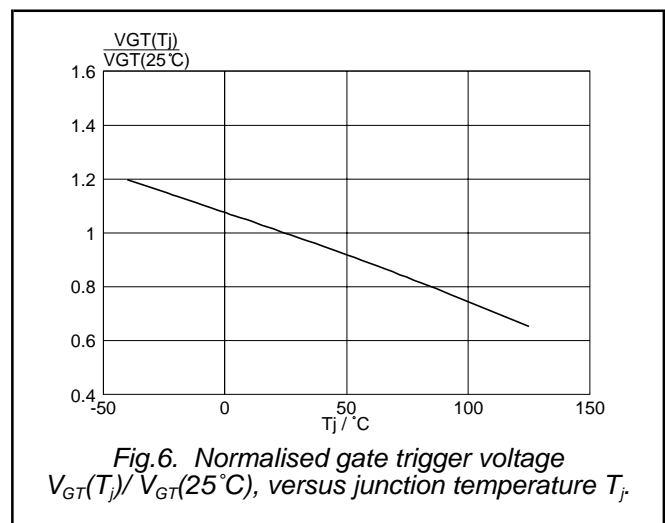
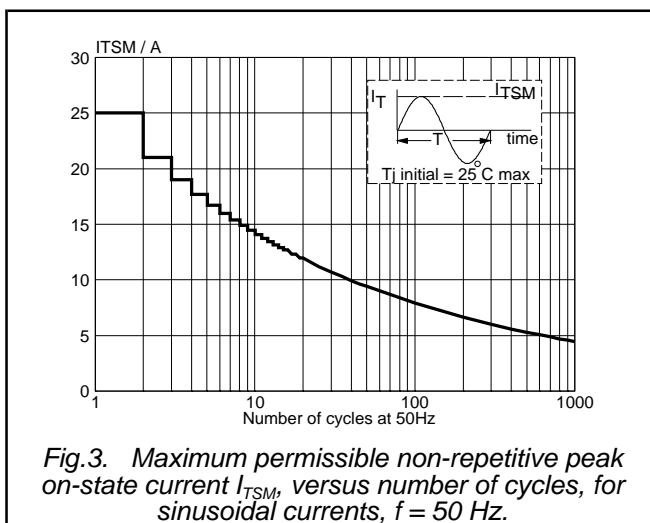
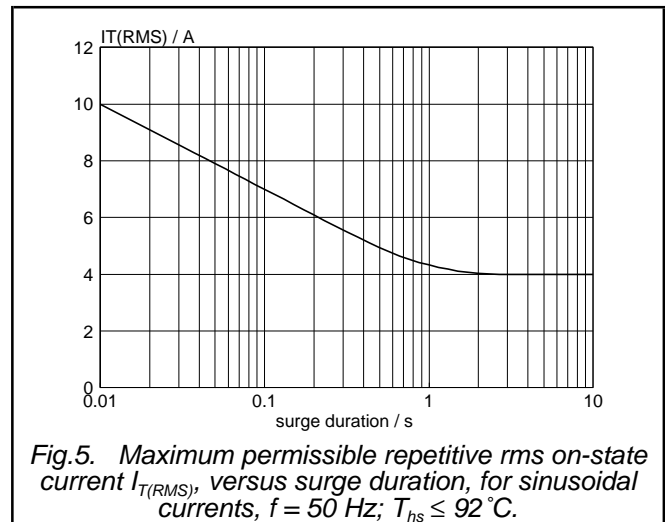
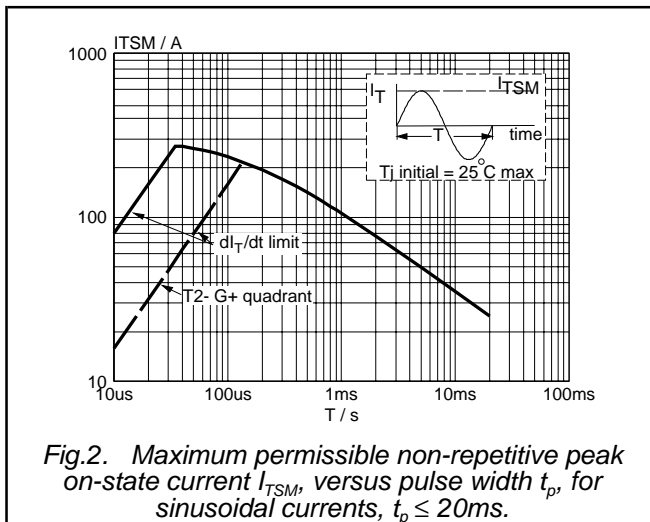
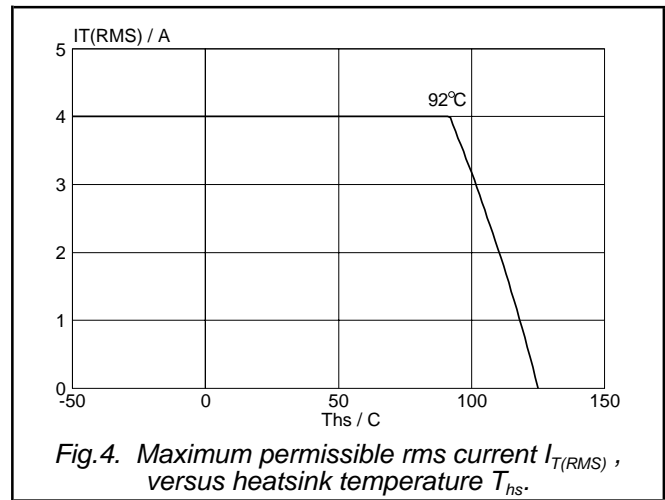
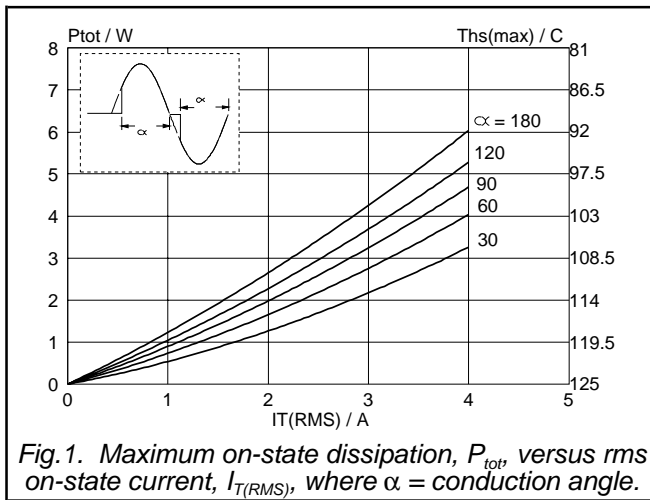
## BT136X series

**DYNAMIC CHARACTERISTICS** $T_j = 25\text{ °C}$  unless otherwise stated

| SYMBOL        | PARAMETER                                      | CONDITIONS                                                                                                                             | MIN. |    | TYP. | MAX. | UNIT       |
|---------------|------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------|------|----|------|------|------------|
|               |                                                |                                                                                                                                        |      |    |      |      |            |
| $dV_D/dt$     | Critical rate of rise of off-state voltage     | <b>BT136X-</b><br>$V_{DM} = 67\% V_{DRM(max)}$ ;<br>$T_j = 125\text{ °C}$ ; exponential waveform; gate open circuit                    | 100  | 50 | 250  | -    | V/ $\mu$ s |
| $dV_{com}/dt$ | Critical rate of change of commutating voltage | $V_{DM} = 400\text{ V}$ ; $T_j = 95\text{ °C}$ ;<br>$I_{T(RMS)} = 4\text{ A}$ ;<br>$dl_{com}/dt = 1.8\text{ A/ms}$ ; gate open circuit | -    | -  | 50   | -    | V/ $\mu$ s |
| $t_{gt}$      | Gate controlled turn-on time                   | $I_{TM} = 6\text{ A}$ ; $V_D = V_{DRM(max)}$ ;<br>$I_G = 0.1\text{ A}$ ; $dl_G/dt = 5\text{ A}/\mu$ s                                  | -    | -  | 2    | -    | $\mu$ s    |

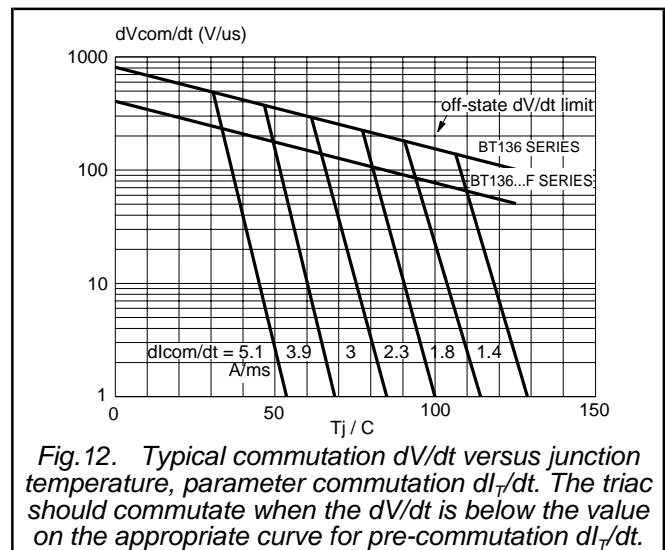
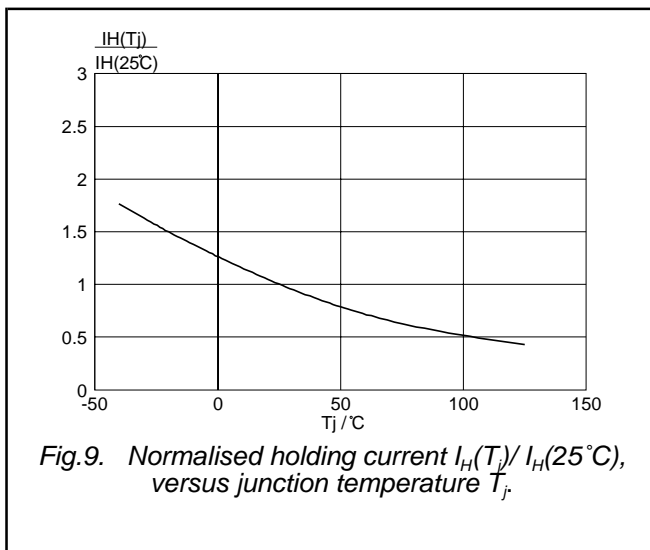
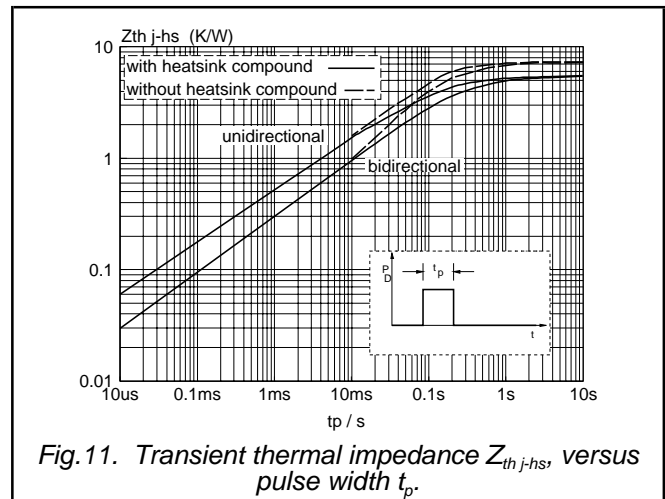
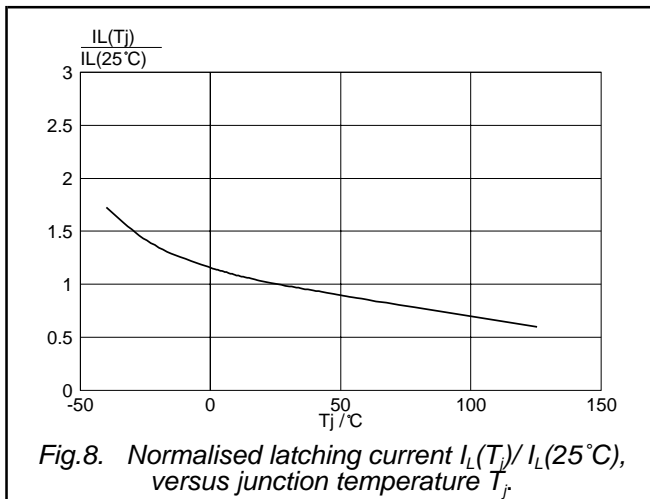
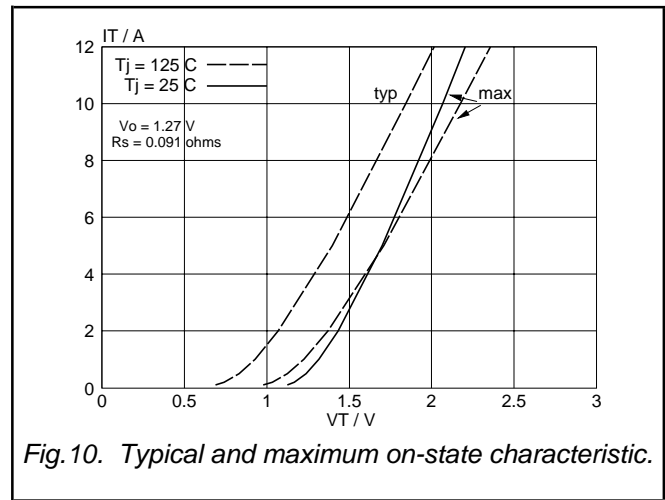
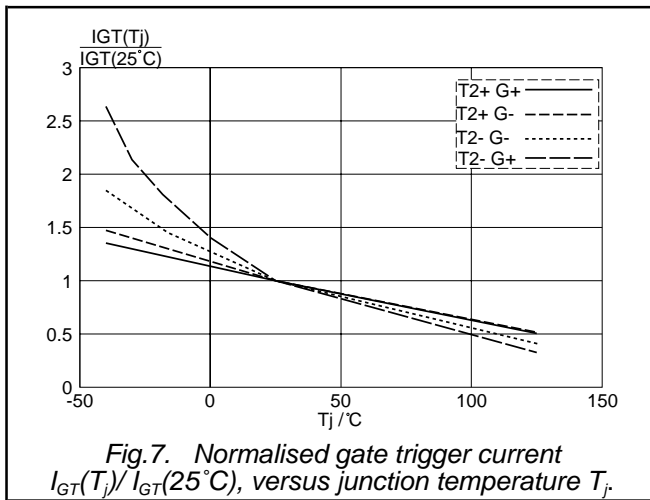
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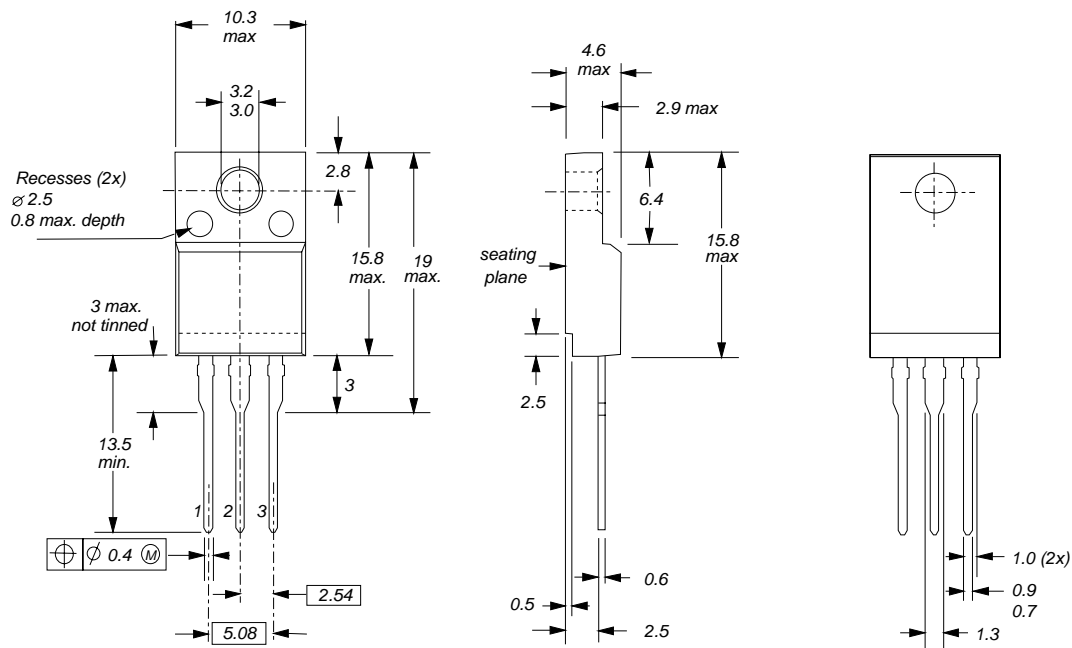
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**MECHANICAL DATA**

*Dimensions in mm*

*Net Mass: 2 g*



*Fig. 13. SOT186A; The seating plane is electrically isolated from all terminals.*

**Notes**

1. Refer to mounting instructions for F-pack envelopes.
2. Epoxy meets UL94 V0 at 1/8".

## Triacs

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**DEFINITIONS**

| <b>DATA SHEET STATUS</b>                                                                                                                                                                                                                                                                                                                                                                                                                                   |                                   |                                                                                                                                                                                                                                                                                                                       |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>DATA SHEET STATUS<sup>2</sup></b>                                                                                                                                                                                                                                                                                                                                                                                                                       | <b>PRODUCT STATUS<sup>3</sup></b> | <b>DEFINITIONS</b>                                                                                                                                                                                                                                                                                                    |
| Objective data                                                                                                                                                                                                                                                                                                                                                                                                                                             | Development                       | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice                                                                                                                            |
| Preliminary data                                                                                                                                                                                                                                                                                                                                                                                                                                           | Qualification                     | This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product                                     |
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| <b>Limiting values</b>                                                                                                                                                                                                                                                                                                                                                                                                                                     |                                   |                                                                                                                                                                                                                                                                                                                       |
| Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability. |                                   |                                                                                                                                                                                                                                                                                                                       |
| <b>Application information</b>                                                                                                                                                                                                                                                                                                                                                                                                                             |                                   |                                                                                                                                                                                                                                                                                                                       |
| Where application information is given, it is advisory and does not form part of the specification.                                                                                                                                                                                                                                                                                                                                                        |                                   |                                                                                                                                                                                                                                                                                                                       |
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